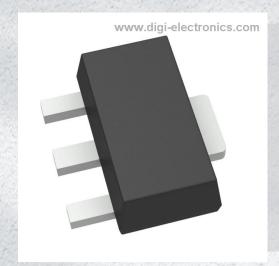


# **FCX1047ATA Datasheet**



https://www.DiGi-Electronics.com

DiGi Electronics Part Number FCX1047ATA-DG

Manufacturer Diodes Incorporated

Manufacturer Product Number FCX1047ATA

Description TRANS NPN 10V 4A SOT89-3

Detailed Description Bipolar (BJT) Transistor NPN 10 V 4 A 150MHz 2 W S

urface Mount SOT-89-3



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



# **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:			
FCX1047ATA	Diodes Incorporated			
Series:	Product Status:			
	Active			
Transistor Type:	Current - Collector (Ic) (Max):			
NPN	4 A			
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, lc:			
10 V	350mV @ 25mA, 5A			
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ Ic, Vce:			
10nA	300 @ 1A, 2V			
Power - Max:	Frequency - Transition:			
2 W	150MHz			
Operating Temperature:	Mounting Type:			
-55°C ~ 150°C (TJ)	Surface Mount			
Package / Case:	Supplier Device Package:			
TO-243AA	SOT-89-3			
Base Product Number:				
FCX1047				

# **Environmental & Export classification**

8541.29.0075

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	





# 10V NPN MEDIUM POWER TRANSISTOR IN SOT89

#### **Features**

- BV<sub>CEO</sub> > 10V
- I<sub>C</sub> = 4A High Continuous Current
- I<sub>CM</sub> = 20A Peak Pulse Current
- High Gain Holds up h<sub>FE</sub> > 300 @ I<sub>C</sub>=1A
- Low Equivalent On-Resistance; R<sub>CE(sat)</sub> = 40mΩ at 4A
- Excellent h<sub>FE</sub> Characteristics up to 20A
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Applications**

- Emergency Lighting Circuits
- Motor Driving (including DC fans)
- Solenoid, Relay and Actuator Drivers
- DC-DC Modules
- Backlight Inverters
- Power Switches
- MOSFET Gate Drivers

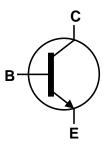
#### **Mechanical Data**

- Case: SOT89
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Lead.
   Solderable per MIL-STD-202, Method 208 @3
- · Weight: 0.052 grams (Approximate)

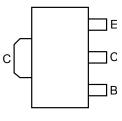


Top View





Device Symbol



Top View Pin-Out

### Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FCX1047ATA	047	7	12	1,000

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**

047

**SOT89** 

047 = Product Type Marking Code





**FCX1047A** 

#### Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	35	V
Collector-Emitter Voltage	V <sub>CEO</sub>	10	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Continuous Collector Current	Ic	4	Α
Peak Pulse Current	I <sub>CM</sub>	20	Α

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
	(Note 5)		1		
Power Dissipation	(Note 6)	$P_{D}$	1.6	W	
	(Note 7)		2.0		
	(Note 5)	$R_{ hetaJA}$	125	°C/W	
Thermal Resistance, Junction to Ambient Air	(Note 6)		78		
	(Note 7)		62.5		
Thermal Resistance, Junction to Lead	(Note 8)	$R_{ heta JL}$	3.6	°C/W	
Operating and Storage Temperature Range		$T_J,T_STG$	-55 to +150	°C	

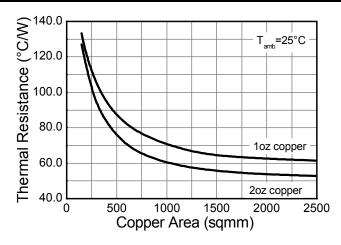
#### ESD Ratings (Note 9)

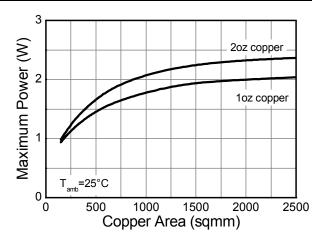
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

- 5. For a device mounted with the exposed collector pad on 15mm x 15mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 6. Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.
- 7. Same as Note 5, except the device is mounted on 50mm x 50mm 1oz copper.
- 8. Thermal resistance from junction to solder-point (on the exposed collector pad).
- 9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

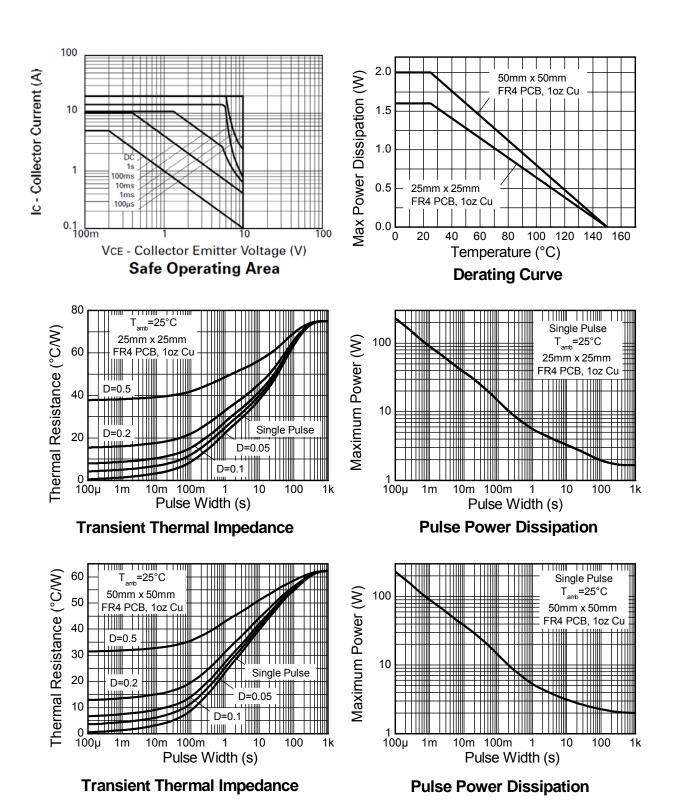
# **Thermal Characteristics and Derating Information**







## Thermal Characteristics and Derating Information (continued)





A Product Line of Diodes Incorporated



**FCX1047A** 

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	35	_	_	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage	BV <sub>CES</sub>	35	_	_	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (Note 10)	BV <sub>CEO</sub>	10	_	_	V	I <sub>C</sub> = 10mA
Collector-Emitter Breakdown Voltage	BV <sub>CEV</sub>	35	_	_	V	I <sub>C</sub> = 100μA, V <sub>EB</sub> = 1V
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	_	_	V	I <sub>E</sub> = 100μA
Collector Cutoff Current	I <sub>CBO</sub>	_	0.3	10	nA	V <sub>CB</sub> = 20V
Collector Cutoff Current	I <sub>CES</sub>	_	0.3	10	nA	V <sub>CES</sub> = 20V
Emitter Cutoff Current	I <sub>EBO</sub>	_	0.3	10	nA	V <sub>EB</sub> = 5.6V
DC Current Transfer Static Ratio (Note 10)  Collector-Emitter Saturation Voltage (Note 10)	h <sub>FE</sub>	280 290 300 200 200 60	430 440 450 350 330 110 25 50 140 160 220	1,200 40 70 200 240 350	mV	$\begin{split} & I_C = 10 \text{mA}, \ V_{CE} = 2 \text{V} \\ & I_C = 0.5 \text{A}, \ V_{CE} = 2 \text{V} \\ & I_C = 1 \text{A}, \ V_{CE} = 2 \text{V} \\ & I_C = 4 \text{A}, \ V_{CE} = 2 \text{V} \\ & I_C = 5 \text{A}, \ V_{CE} = 2 \text{V} \\ & I_C = 20 \text{A}, \ V_{CE} = 2 \text{V} \\ & I_C = 0.5 \text{A}, \ I_B = 10 \text{mA} \\ & I_C = 1 \text{A}, \ I_B = 10 \text{mA} \\ & I_C = 3 \text{A}, \ I_B = 15 \text{mA} \\ & I_C = 4 \text{A}, \ I_B = 50 \text{mA} \\ \end{split}$
Base-Emitter Saturation Voltage (Note 10)	V <sub>BE(sat)</sub>	_	920	1.000	mV	$I_C = 5A$ , $I_B = 25mA$ $I_C = 4A$ , $I_B = 50mA$
Base-Emitter Turn-on Voltage (Note 10)	V <sub>BE(on)</sub>	_	860	950	mV	I <sub>C</sub> = 4A, V <sub>CE</sub> = 2V
Transitional Frequency	f <sub>T</sub>	_	150	_	MHz	I <sub>C</sub> = 50mA, V <sub>CE</sub> = 10V, f = 50MHz
Output Capacitance	C <sub>obo</sub>	_	85	_	pF	V <sub>CB</sub> = 10V, f = 1MHz,
Switching Time	ton		130		ns	V <sub>CC</sub> = 10V, I <sub>C</sub> = 4A,
Switching Time	t <sub>off</sub>		230	_	ns	$I_{B1} = I_{B2} = \pm 40 \text{mA}$

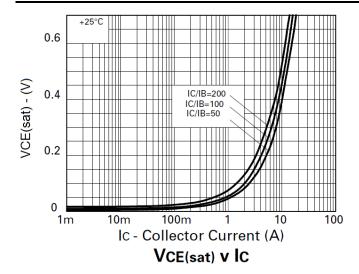
Note:

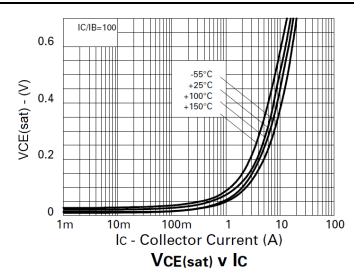
10. Measured under pulsed conditions. Pulse width =  $300\mu s$ . Duty cycle  $\leq 2\%$ .

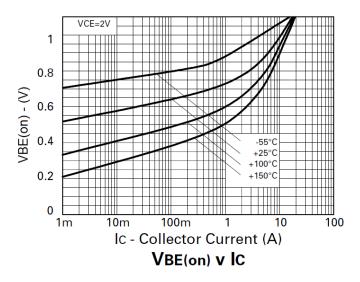


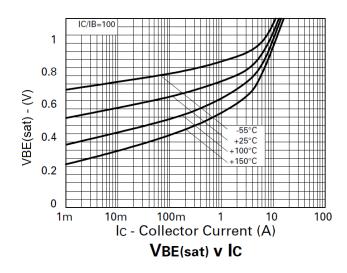


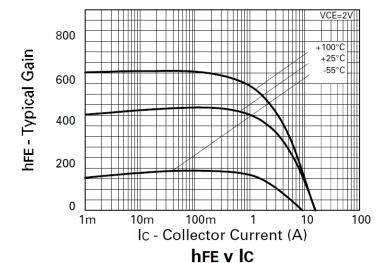
# Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)









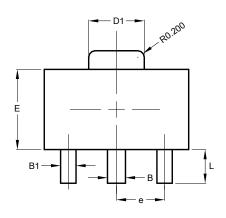


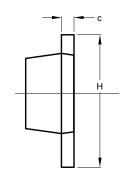


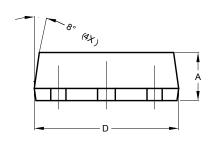
FCX1047A

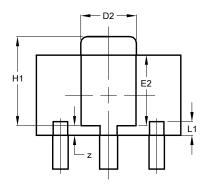
# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.





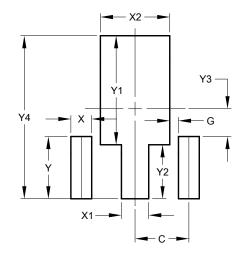




SOT89					
Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
В	0.50	0.62	0.56		
B1	0.42	0.54	0.48		
C	0.35	0.43	0.38		
D	4.40	4.60	4.50		
D1	1.62	1.83	1.733		
D2	1.61	1.81	1.71		
Е	2.40	2.60	2.50		
E2	2.05	2.35	2.20		
е	ı	ı	1.50		
Н	3.95	4.25	4.10		
H1	2.63	2.93	2.78		
L	0.90	1.20	1.05		
L1	0.427 REF				
Z	0.30 REF				
All Dimensions in mm					

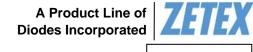
# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	1.500		
G	0.244		
X	0.580		
X1	0.760		
X2	1.933		
Υ	1.730		
Y1	3.030		
Y2	1.500		
Y3	0.770		
Y4	4.530		





**FCX1047A** 

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